



GT25FF120B9H

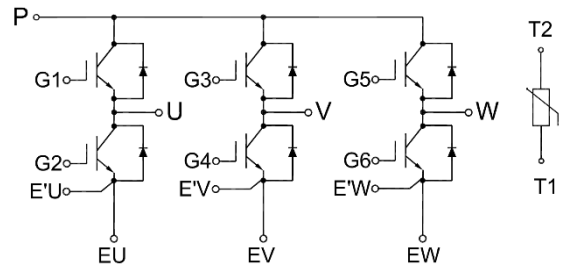
IGBT Module

Preliminary Data

Features:

- Field Stop Trench Gate IGBT
- Short Circuit Rated $>10\mu\text{s}$
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested($2\times I_c$)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement

Circuit Diagram



Applications:

- Motor Drives
- UPS
- Air Conditioning
- Auxiliary Inverters

IGBT, Inverter

Maximum Rated Values ($T_C=25^\circ\text{C}$ unless otherwise specified)

V_{CES}	Collector-Emitter Blocking Voltage		1200	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	Continuous Collector Current	$T_C=100^\circ\text{C}$	25	A
		$T_C=25^\circ\text{C}$	50	A
I_{CM}	Repetitive Peak Collector Current	$t_P=1\text{ms}$	50	A
P_D	Maximum Power Dissipation per IGBT	$T_C=25^\circ\text{C}$ $T_{Jmax}=175^\circ\text{C}$	280	W



Electrical Characteristics of IGBT ($T_C=25^{\circ}\text{C}$ unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=1\text{mA}$, $V_{CE}=V_{GE}$	5.0	5.6	6.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=25\text{A}$, $V_{GE}=15\text{V}$	$T_J=25^{\circ}\text{C}$	1.75	2.10	V
			$T_J=125^{\circ}\text{C}$	2.10		
			$T_J=150^{\circ}\text{C}$	2.20		
I_{CES}	Collector-Emitter Leakage Current	$V_{GE}=0\text{V}$, $V_{CE}=V_{CES}$, $T_J=25^{\circ}\text{C}$			1	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=\pm 20\text{V}$, $V_{CE}=0\text{V}$, $T_J=25^{\circ}\text{C}$			200	nA
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}$, $V_{GE}=0\text{V}$, $f=100\text{kHz}$		1.64		nF
C_{oes}	Output Capacitance			0.44		
C_{res}	Reverse Transfer Capacitance			0.02		

Switching Characteristics

t _{d(on)}	Turn-on Delay Time	V _{CC} =600V, I _C =25A, R _{Gon} =20Ω, V _{GE} =±15V, Inductive Load	T _J =25℃		57		ns
			T _J =125℃		58		
			T _J =150℃		62		
t _r	Rise Time		T _J =25℃		55		ns
			T _J =125℃		58		
			T _J =150℃		60		
t _{d(off)}	Turn-off Delay Time	V _{CC} =600V, I _C =25A, R _{Goff} =20Ω, V _{GE} =±15V, Inductive Load	T _J =25℃		208		ns
			T _J =125℃		211		
			T _J =150℃		214		
t _f	Fall Time		T _J =25℃		76		ns
			T _J =125℃		223		
			T _J =150℃		225		
E _{on}	Turn-on Switching Loss	V _{CC} =600V, I _C =25A, R _{Gon} =20Ω, V _{GE} =±15V, di/dt=368A/μs (T _J =150℃) Inductive Load	T _J =25℃		3.1		mJ
			T _J =125℃		3.8		
			T _J =150℃		4.1		



E _{off}	Turn-off Switching Loss	V _{CC} =600V, I _C =25A, R _{Goff} =20Ω, V _{GE} =±15V, du/dt=4543V/μs (T _J =150°C) Inductive Load	T _J =25°C		2.1		mJ
			T _J =125°C		2.4		
			T _J =150°C		2.5		
Q _g	Total Gate Charge	V _{GE} =+15V...-15V	T _J =25°C		400		nC
R _{G(int)}	Internal Gate Resistor		T _J =25°C		0		Ω
I _{SC}	V _{CC} =600V, V _{GE} =+/-15V, T _J =25°C				100		A
R _{θJC}	Thermal Resistance: Junction-to-Case (per IGBT)					0.54	°C/W

FWD, Inverter

Maximum Rated Values (T_C=25°C unless otherwise specified)

V _{RRM}	Repetitive Peak Reverse Voltage	T _J =25°C	1200	V
I _F	Diode Continuous Forward Current		25	A
I _{FM}	Diode Maximum Forward Current	t _p =1ms	50	A

Electrical Characteristics of Diode (T_C=25°C unless otherwise specified)

Symbol	Description	Conditions		Min.	Typ.	Max.	Units
V _{FM}	Forward Voltage	I _F =25A	T _J =25°C		1.70		V
			T _J =125°C		1.85		
			T _J =150°C		1.85		
t _{rr}	Reverse Recovery Time	I _F =25A, -di _F /dt=271A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C		312		ns
			T _J =125°C		489		
			T _J =150°C		540		
I _{rr}	Peak Reverse Recovery Current		T _J =25°C		16.2		A
			T _J =125°C		19.3		
			T _J =150°C		20.5		
Q _{rr}	Reverse Recovery Charge		T _J =25°C		2.5		μC
			T _J =125°C		4.3		
			T _J =150°C		4.4		



E _{rec}	Reverse Recovery Energy	I _F =25A, -di _F /dt=271A/μs(T _J =150℃), V _R =600V, V _{GE} =-15V	T _J =25℃		0.7		mJ
			T _J =125℃		1.4		
			T _J =150℃		1.5		
R _{θJC}	Diode Thermal Resistance: Junction-to-Case(per Leg)					0.97	℃/W

Internal NTC-Thermistor Characteristics

Symbol	Conditions	Min.	Typ.	Max.	Units
R ₂₅	T _C =25°C		5		kΩ
ΔR/R	T _C =100°C, R ₁₀₀ =465Ω	-5		+5	%
P ₂₅	T _C =25°C			10	mW
B _{25/50}	$R_2=R_{25} \exp[B_{25/50}(1/T_2-1/(298.15K))]$		3380		K
B _{25/80}	$R_2=R_{25} \exp[B_{25/80}(1/T_2-1/(298.15K))]$		3440		K
B _{25/100}	$R_2=R_{25} \exp[B_{25/100}(1/T_2-1/(298.15K))]$		3545		K



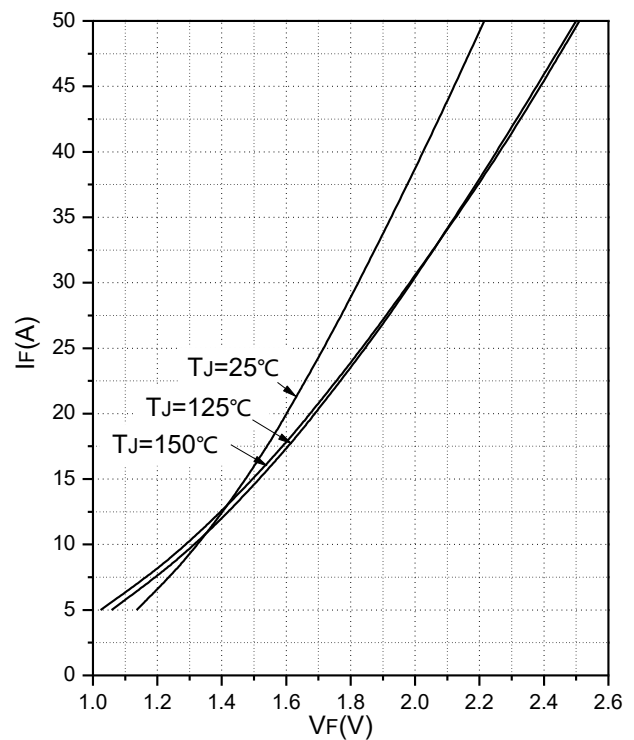
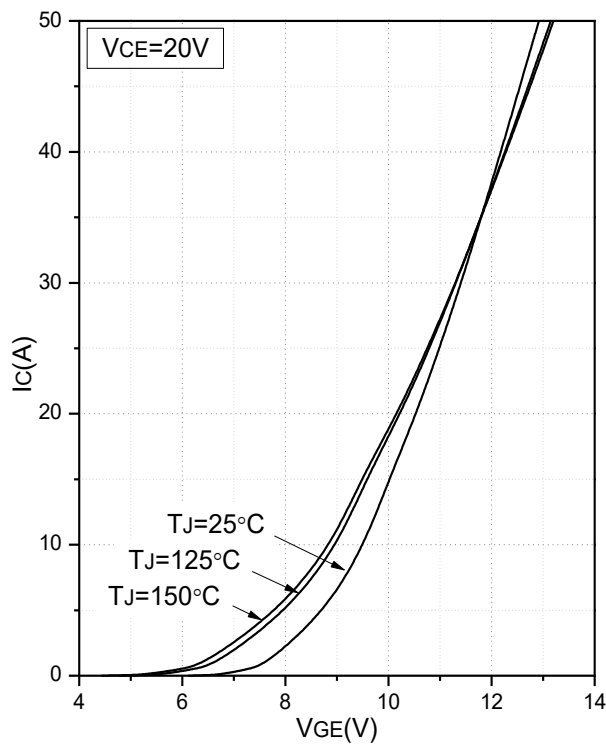
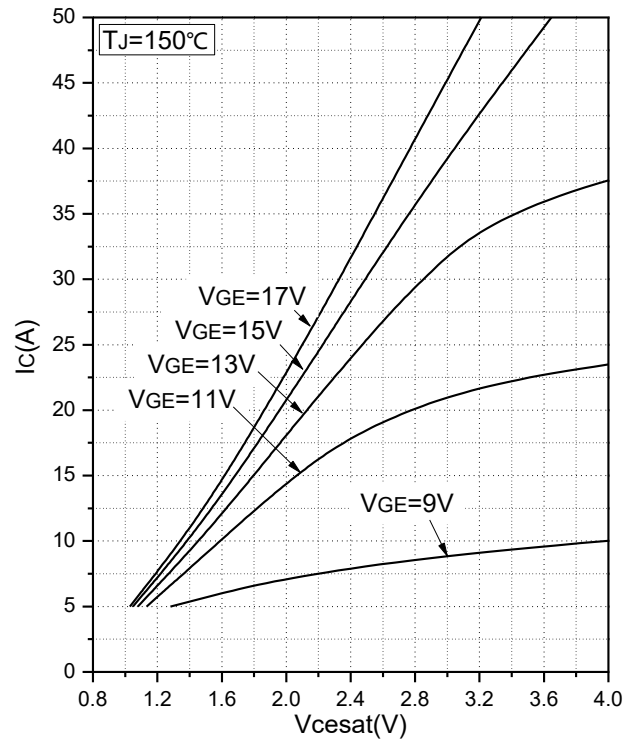
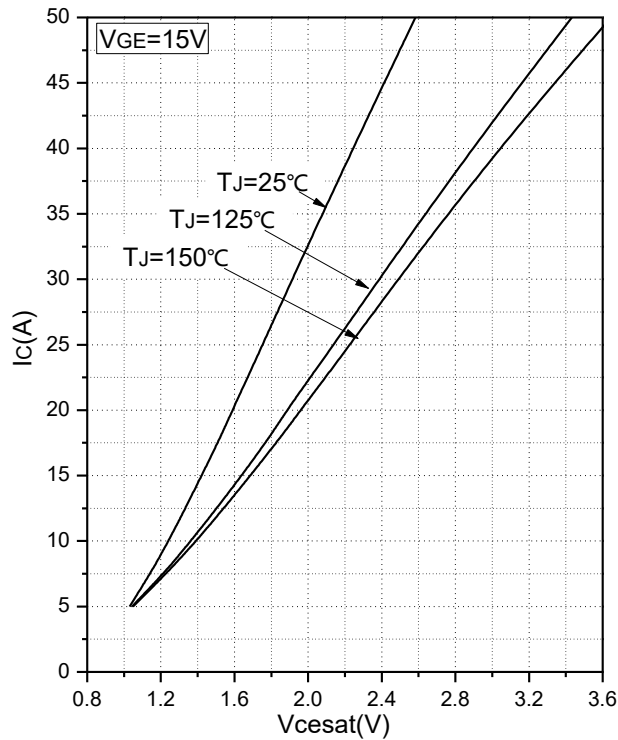
Module

Symbol	Description		Min.	Typ.	Max.	Units
V _{iso}	Isolation Voltage(All Terminals Shorted)	RMS, 50Hz, 1minute	2500			V
T _J	Maximum Junction Temperature				175	°C
T _{JOP}	Maximum Operating Junction Temperature Range		-40		+150	°C
T _{stg}	Storage Temperature		-40		+125	°C
CTI	Comparative Tracking Index		200			
R _{θCS}	Case-to-Sink Thermally (Conductive Grease Applied)				0.05	°C/W
M	Mounting Screw:M4		1.5		1.8	N·m
G	Weight			40		g

Ordering Information Table

Device code	G	T	25	FF	120	B9	H
	①	②	③	④	⑤	⑥	⑦

- ① - IGBT Module
- ② - Trench, Low Switching Losses IGBT
- ③ - Rated Current (25=25A)
- ④ - Circuit Configuration (Full Bridge)
- ⑤ - Rated Voltage (120=1200V)
- ⑥ - Package Type
- ⑦ - Test Level (Pass the Important Reliability Test-Industrial Grade)



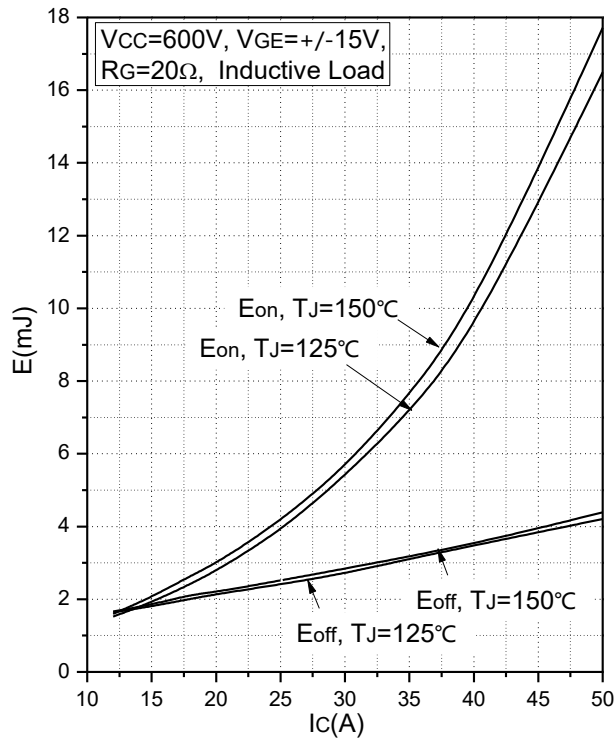


Fig.5 Typical Switching Loss vs. Collector Current (Inverter)

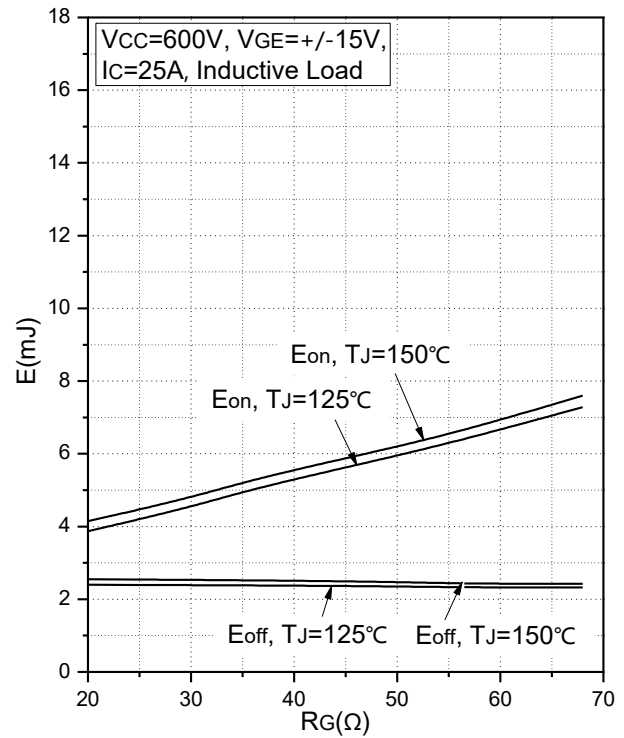


Fig.6 Typical Switching Loss vs. Gate Resistance (Inverter)

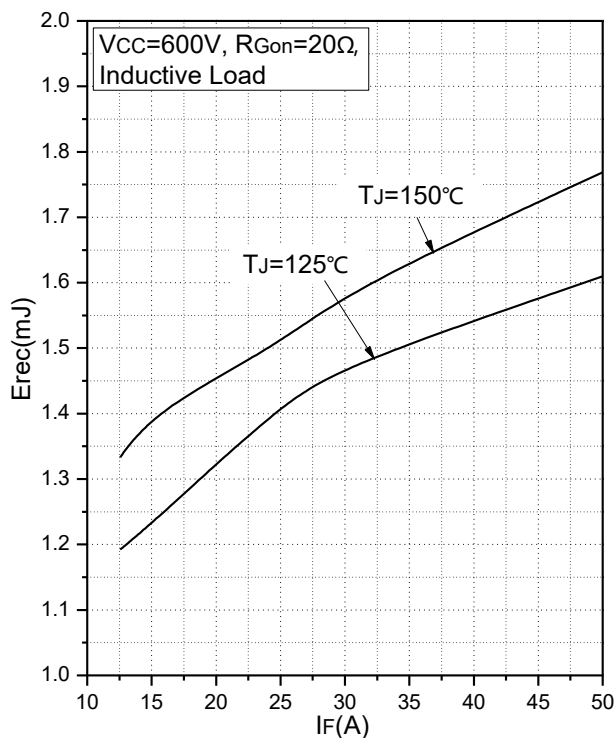


Fig.7 Typical Switching Loss vs. Forward Current (Inverter)

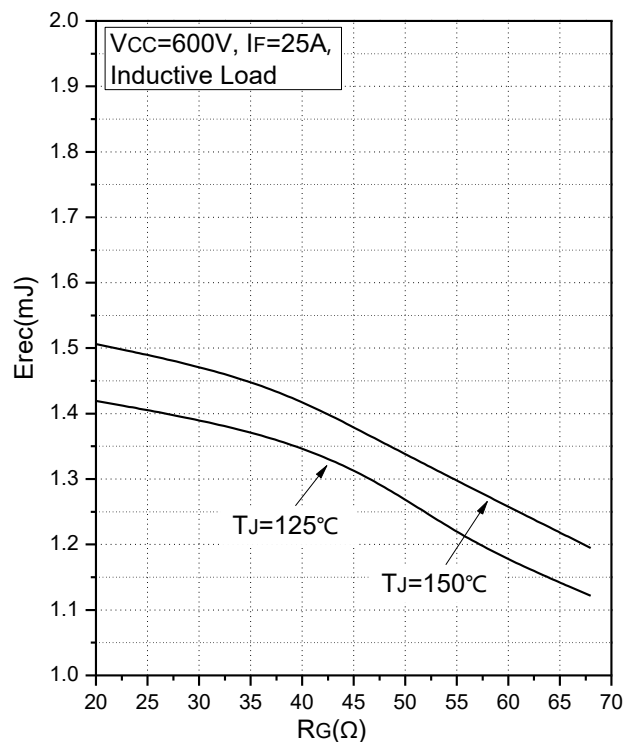
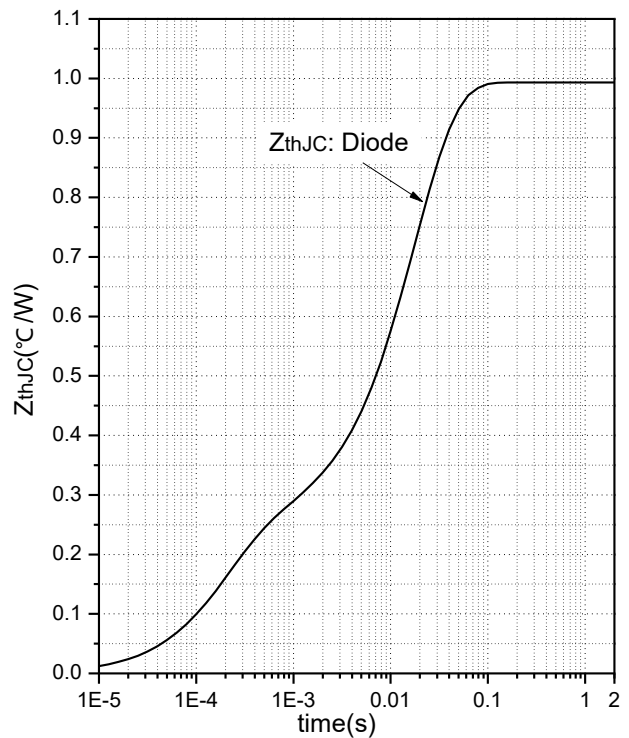
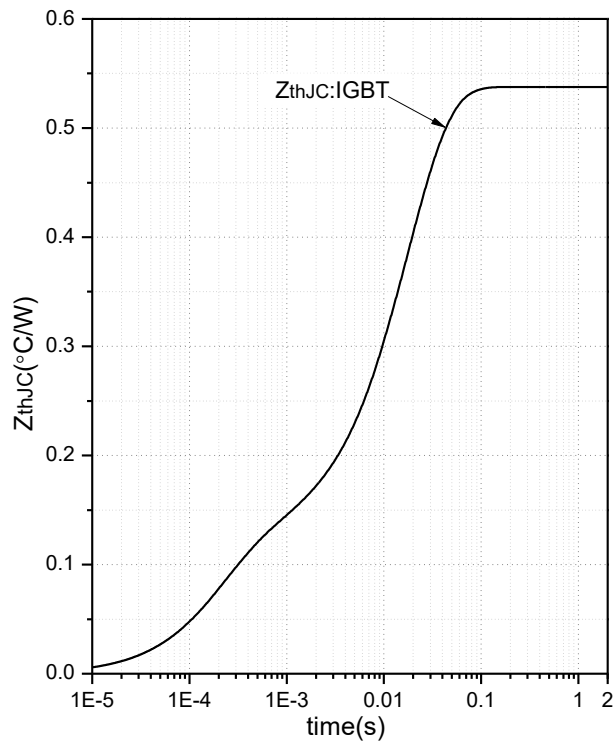
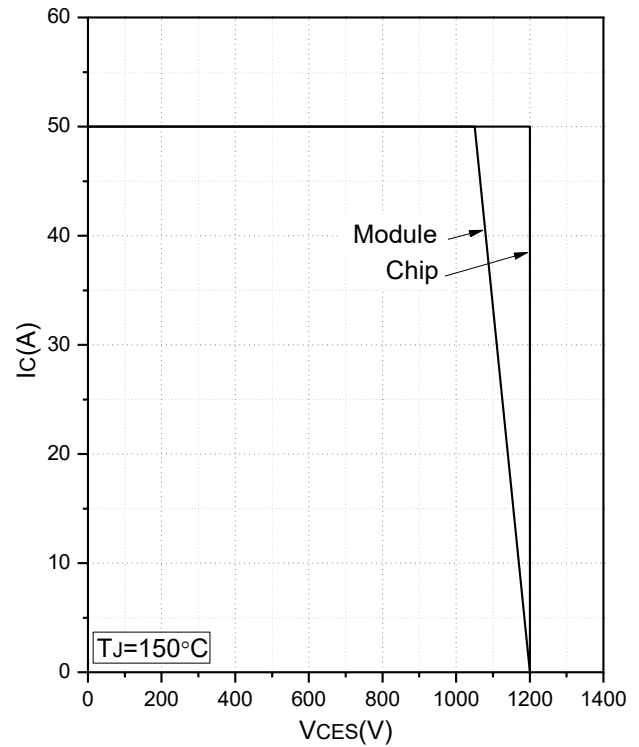
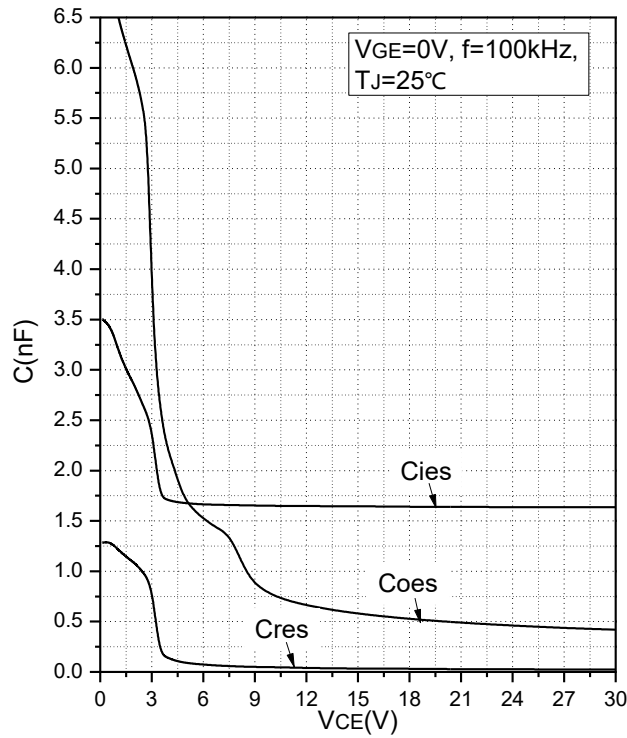


Fig.8 Typical Switching Loss vs. Gate Resistance (Inverter)



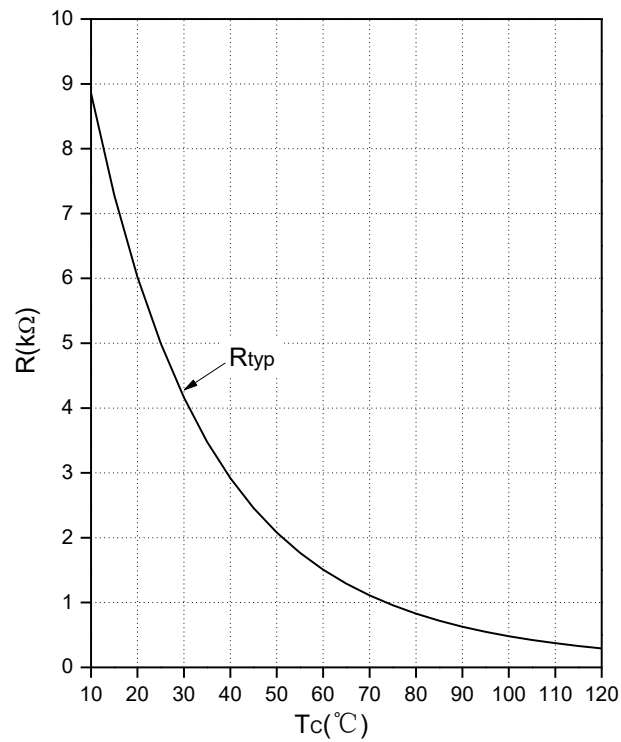
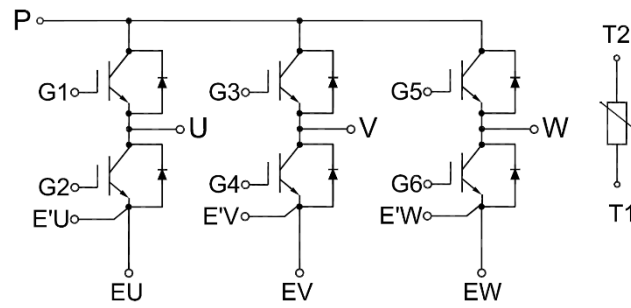


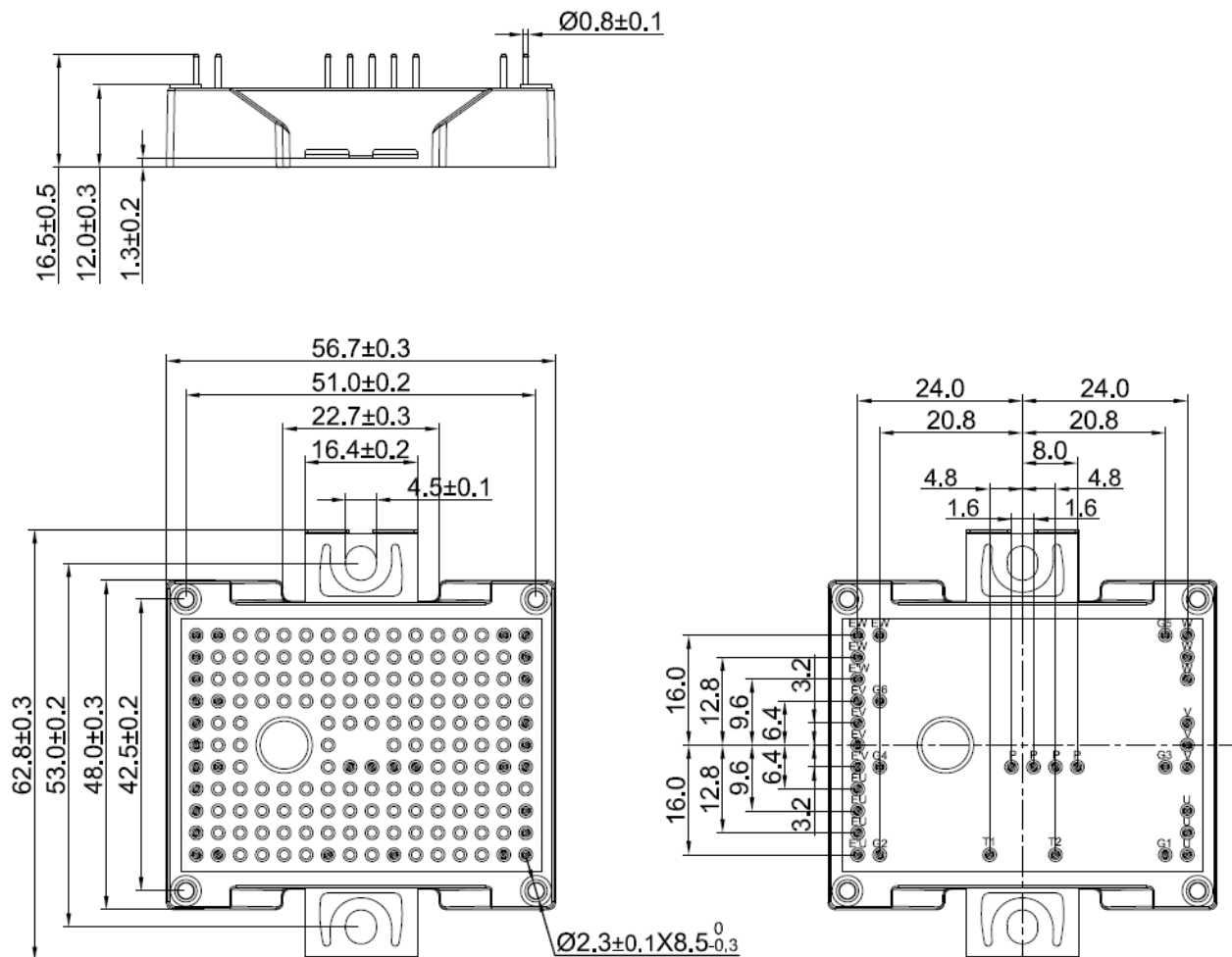
Fig.13 NTC Temperature Characteristics



Internal Circuit



Package Outline(Unit: mm):





Revision	Notes
01	Initial Release

Announcement

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